

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDEBOARD #: TIDA-00200REV: E1SVN REV: Not In VersionControlIGNORE ->Top OverlayPLOT NAME = Top Assembly DrawingGENERATED : 7/23/2014 6:28:39 PMTEXAS INSTRUMENTS

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00200	REV: E1	SVN REV	: Not In VersionControl
	Bottom Overlay <- 390001			
PLOT NAME = Bottom Assembly Drawing	GENERATED : 7/23/2	2014 6:28:41	PM	TEXAS INSTRUMENTS

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